

# **LET9002**

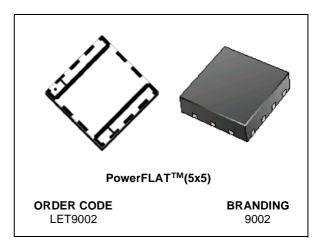
## RF POWER TRANSISTORS

# Ldmos Enhanced Technology in Plastic Package

TARGET DATA

N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

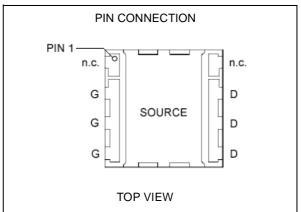
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- P<sub>OUT</sub> = 2 W with 17 dB gain @ 960 MHz / 26 V
- NEW LEADLESS PLASTIC PACKAGE
- ESD PROTECTION
- SUPPLIED IN TAPE & REEL OF 3K UNITS



#### **DESCRIPTION**

The LET9002 is a common source N-Channel, enhancement-mode lateral Field-Effect RF power transistor designed for broadband commercial and industrial applications at frequencies up to 1000 MHz. The LET9002 is designed for high gain and broadband performance operating in common source mode at 26 V. LET9002 boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology mounted in the innovative leadless SMD plastic package, PowerFLAT™.

It is ideal for digital cellular BTS applications requiring high linearity.



#### ABSOLUTE MAXIMUM RATINGS (TCASE = 25 °C)

Symbol	Parameter	Value	Unit			
V <sub>(BR)DSS</sub>	Drain-Source Voltage	65	V			
V <sub>GS</sub>	Gate-Source Voltage	-0.5 to +15	V			
I <sub>D</sub>	Drain Current	0.25	Α			
P <sub>DISS</sub>	Power Dissipation (@ Tc = 70°C)	4	W			
Tj	Max. Operating Junction Temperature	150	°C			
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C			

#### THERMAL DATA

R <sub>th(j-c)</sub>	Junction -Case Thermal Resistance	20	°C/W	
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April, 15 2003

## **ELECTRICAL SPECIFICATION (T<sub>CASE</sub> = 25 °C)**

### **STATIC**

Symbol		Test Condition	ons	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V	I <sub>DS</sub> = 1 mA		65			V
I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V				1	μΑ
I <sub>GSS</sub>	V <sub>GS</sub> = 5 V	V <sub>DS</sub> = 0 V				1	μΑ
V <sub>GS(Q)</sub>	V <sub>DS</sub> = 26 V	I <sub>D</sub> = TBD		2.0		5.0	V
V <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 125 mA				0.9	V
9FS	V <sub>DS</sub> = 10 V	$I_D = 200 \text{ mA}$					mho
C <sub>ISS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF
Coss	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF
C <sub>RSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF

### **DYNAMIC** (f = 960 MHz)

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
P <sub>out</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}  I_{DQ} = \text{TBD}$	2.5	3		W
η <sub>D</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 2 \text{ W}$	55	65		%
Load mismatch	V <sub>DD</sub> = 26 V I <sub>DQ</sub> = TBD P <sub>OUT</sub> = 2 W ALL PHASE ANGLES			10:1	VSWR

### (1) 1 dB Compression point

### **DYNAMIC** (*f* = 920 - 960 MHz)

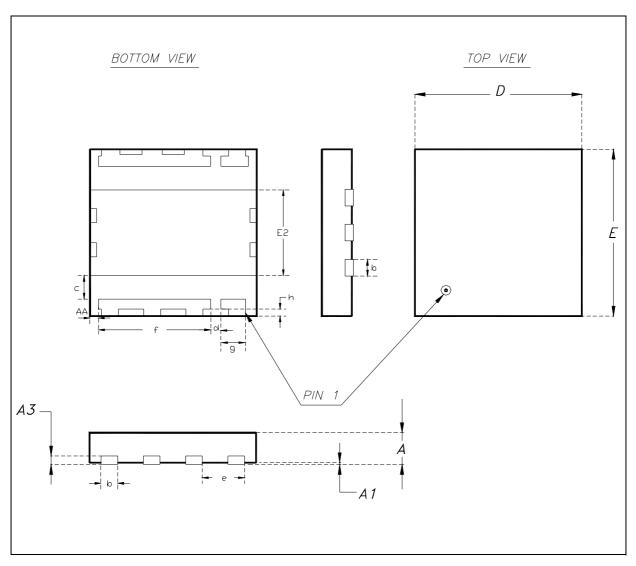
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Pout <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$	2	2.5		W
η <sub>D</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}  I_{DQ} = \text{TBD}$	55	60		%
G <sub>P</sub>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 2 \text{ W}$	17			dB

<sup>(1) 1</sup> dB Compression point

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# **PowerFLAT™ MECHANICAL DATA**

DIM.		mm			Inch	
Dilvi.	MIN.	TYP.	MAX	MIN.	TYP.	MAX
Α		0.90	1.00		0.035	0.039
A1		0.02	0.05		0.001	0.002
А3		0.24			0.009	
AA	0.15	0.25	0.35	0.006	0.01	0.014
b	0.43	0.51	0.58	0.017	0.020	0.023
С	0.64	0.71	0.79	0.025	0.028	0.031
D		5.00			0.197	
d		0.30			0.011	
E		5.00			0.197	
E2	2.49	2.57	2.64	0.098	0.101	0.104
е		1.27			0.050	
f		3.37			0.132	
g		0.74			0.03	
h		0.21			0.008	



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